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Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China





BAV70SRA

Quad high-speed switching diodes

26 June 2017

Product data sheet

1. General description

Quad high-speed switching diodes with common cathode configurations encapsulated in a leadless ultra small DFN1412-6 (SOT1268) Surface-Mounted Device (SMD) plastic package.

2. Features and benefits

- High switching speed: $t_{rr} \leq 4$ ns
- Low leakage current: $I_R \leq 0.5$ μ A
- Reverse voltage $V_R \leq 100$ V
- Low capacitance $C_d \leq 1.5$ pF
- Ultra small SMD plastic package
- AEC-Q101 qualified

3. Applications

- High-speed switching
- General-purpose switching

4. Quick reference data

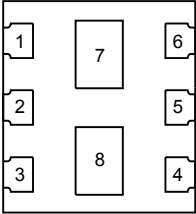
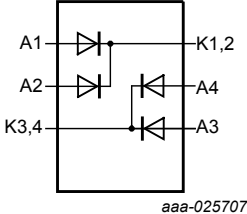
Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
Per diode							
I_F	forward current	single diode loaded; $T_{amb} = 25$ °C	[1]	-	-	355	mA
I_R	reverse current	$V_R = 80$ V; pulsed; $T_j = 25$ °C		-	-	0.5	μ A
V_R	reverse voltage	$T_j = 25$ °C		-	-	100	V
t_{rr}	reverse recovery time	$I_F = 10$ mA; $I_R = 10$ mA; $R_L = 100$ Ω ; $I_{R(meas)} = 1$ mA; $T_{amb} = 25$ °C		-	-	4	ns

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	A1	anode (diode 1)	 <p>Transparent top view DFN1412-6 (SOT1268)</p>	 <p>aaa-025707</p>
2	A2	anode (diode 2)		
3	K3,4	com. cathode (diodes 3, 4)		
4	A3	anode (diode 3)		
5	A4	anode (diode 4)		
6	K1,2	com. cathode (diodes 1, 2)		
7	K1,2	com. cathode (diodes 1, 2)		
8	K3,4	com. cathode (diodes 3, 4)		

6. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
BAV70SRA	DFN1412-6	plastic, thermal enhanced ultra thin small outline package; no leads; 6 terminals; 1.4 mm x 1.2 mm x 0.47 mm body	SOT1268

7. Marking

Table 4. Marking codes

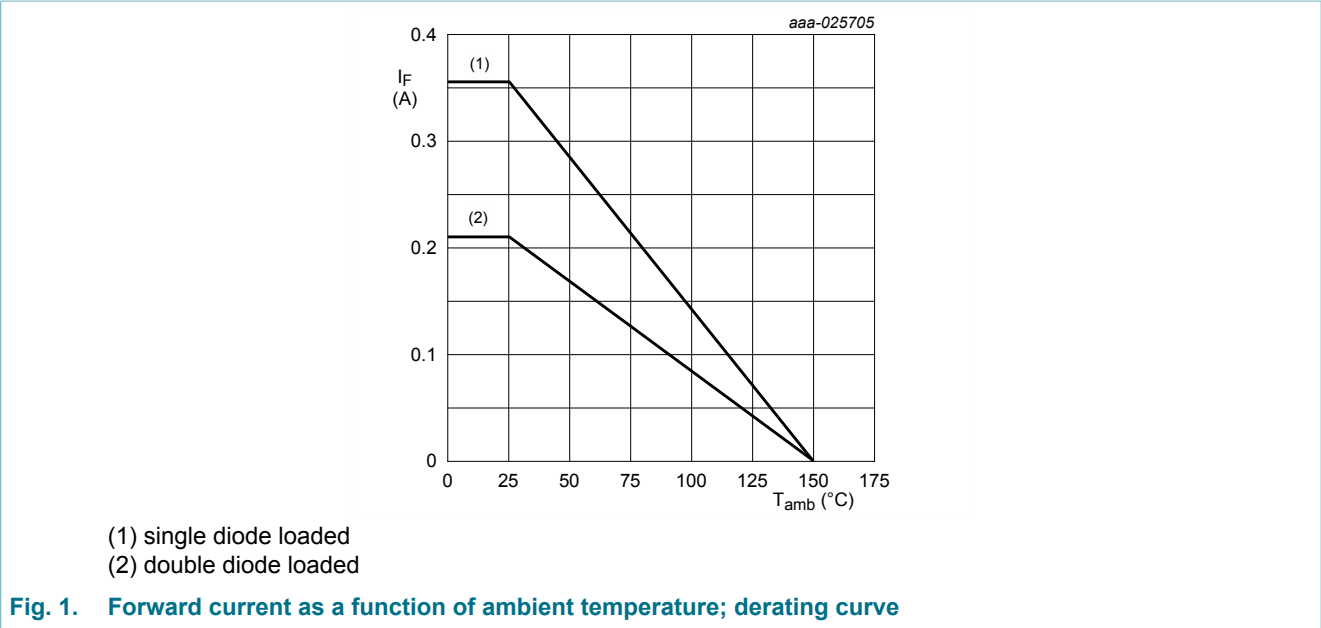
Type number	Marking code
BAV70SRA	A3

8. Limiting values

Table 5. Limiting values
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
Per diode						
V _R	reverse voltage	T _j = 25 °C		-	100	V
I _F	forward current	single diode loaded; T _{amb} = 25 °C	[1]	-	355	mA
		double diodes loaded; T _{amb} = 25 °C	[1]	-	210	mA
I _{FSM}	non-repetitive peak forward current	t _p = 100 µs; T _{j(init)} = 25 °C; square wave		-	4	A
		t _p = 1 ms; T _{j(init)} = 25 °C; square wave		-	1.5	A
		t _p = 1 s; T _{j(init)} = 25 °C; square wave		-	0.5	A
I _{FRM}	repetitive peak forward current	t _p ≤ 0.5 ms; δ ≤ 0.25		-	1	A
Per device; one diode loaded						
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C	[1]	-	410	mW
			[2]	-	610	mW
T _j	junction temperature			-	150	°C
T _{amb}	ambient temperature			-55	150	°C
T _{stg}	storage temperature			-65	150	°C

- [1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.
[2] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated mounting pad for cathode 1cm².



9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air	[1]	-	-	305	K/W
			[2]	-	-	205	K/W
$R_{th(j-sp)}$	thermal resistance from junction to solder point		[3]	-	-	40	K/W

- [1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated mounting pad for cathode 1cm².
[3] Soldering point of cathode tab.

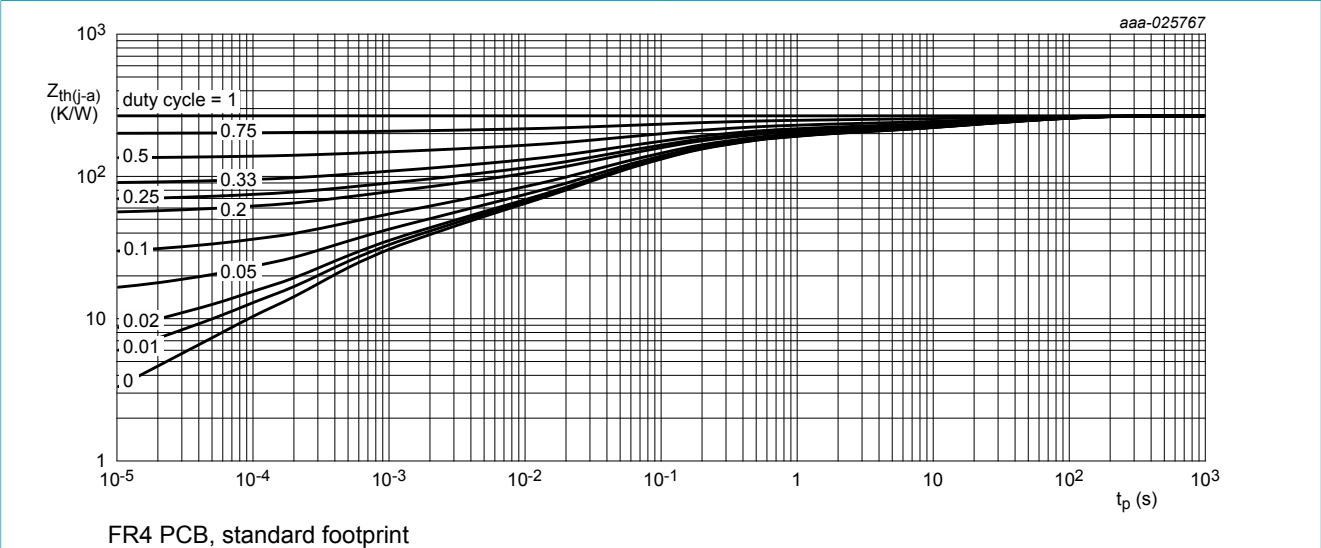


Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

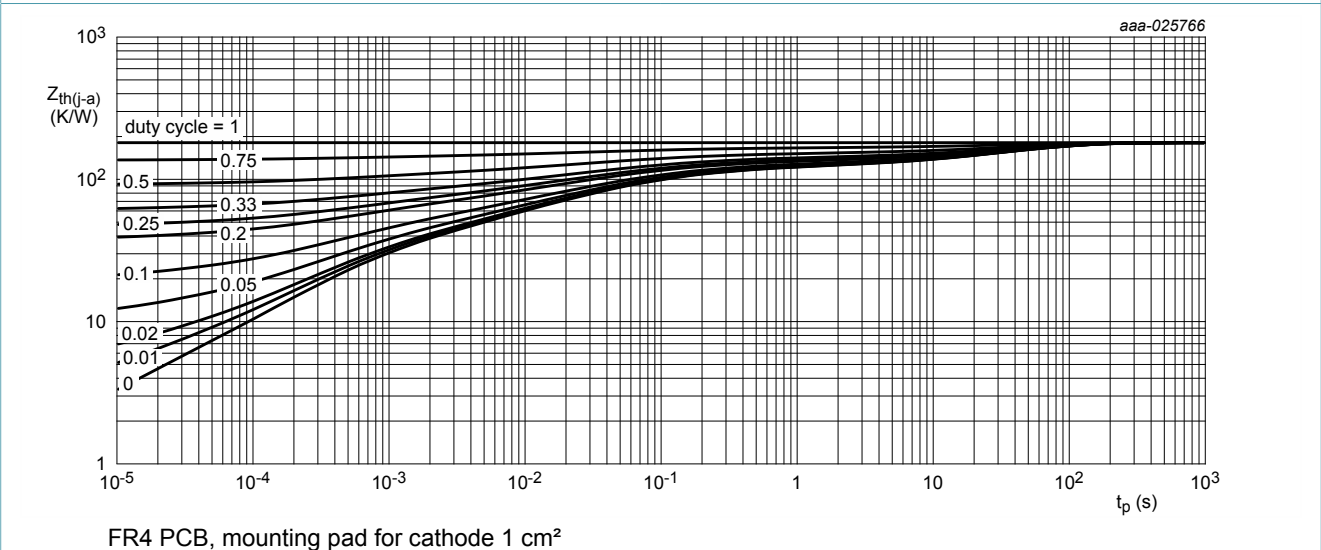


Fig. 3. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

10. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
Per diode						
V _F	forward voltage	I _F = 1 mA; t _p ≤ 300 μs; δ ≤ 0.02 ; T _j = 25 °C	-	-	715	mV
		I _F = 10 mA; t _p ≤ 300 μs; δ ≤ 0.02 ; T _j = 25 °C	-	-	855	mV
		I _F = 50 mA; t _p ≤ 300 μs; δ ≤ 0.02 ; T _j = 25 °C	-	-	1	V
		I _F = 150 mA; t _p ≤ 300 μs; δ ≤ 0.02 ; T _j = 25 °C	-	-	1.25	V
I _R	reverse current	V _R = 25 V; pulsed; T _j = 25 °C	-	-	30	nA
		V _R = 80 V; pulsed; T _j = 25 °C	-	-	0.5	μA
		V _R = 25 V; pulsed; T _j = 150 °C	-	-	30	μA
		V _R = 80 V; pulsed; T _j = 150 °C	-	-	100	μA
C _d	diode capacitance	V _R = 0 V; f = 1 MHz; T _j = 25 °C	-	-	1.5	pF
t _{rr}	reverse recovery time	I _F = 10 mA; I _R = 10 mA; R _L = 100 Ω; I _{R(meas)} = 1 mA; T _{amb} = 25 °C	-	-	4	ns
V _{FRM}	peak forward recovery voltage	I _F = 10 mA; t _r = 20 ns	-	-	1.75	V

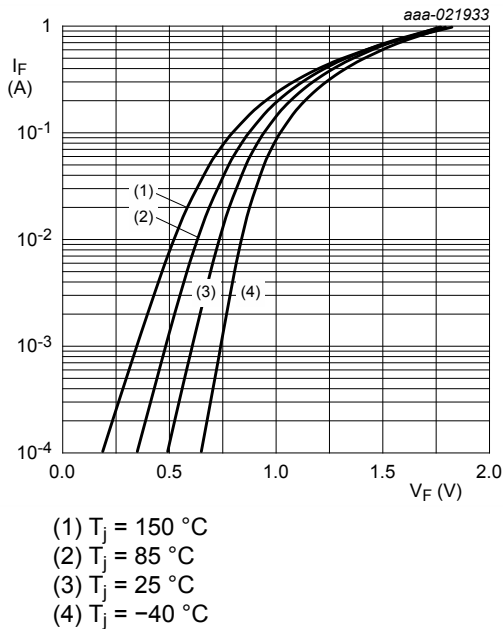


Fig. 4. Forward current as a function of forward voltage; typical values

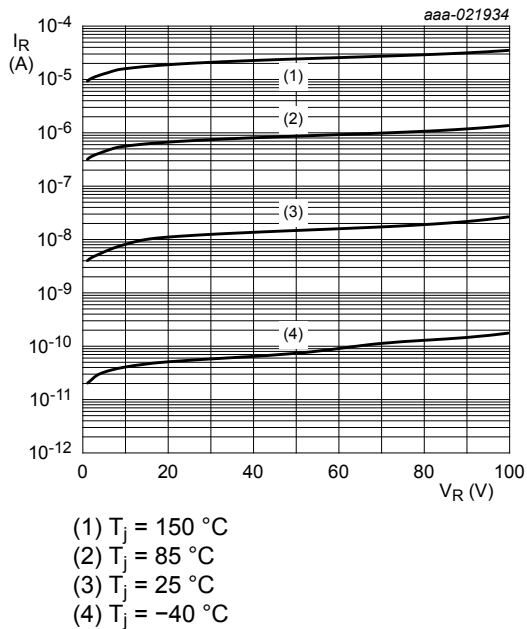


Fig. 5. Reverse current as a function of reverse voltage; typical values

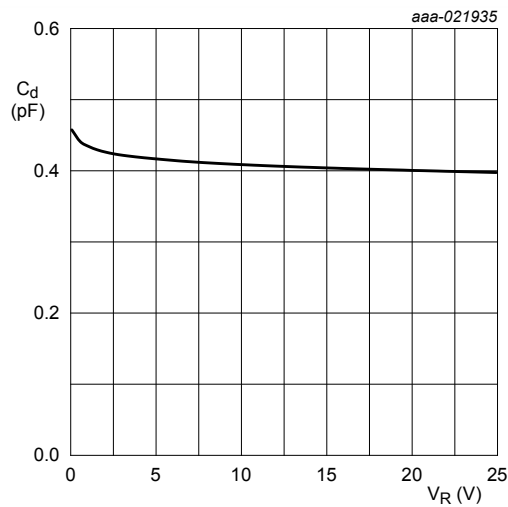
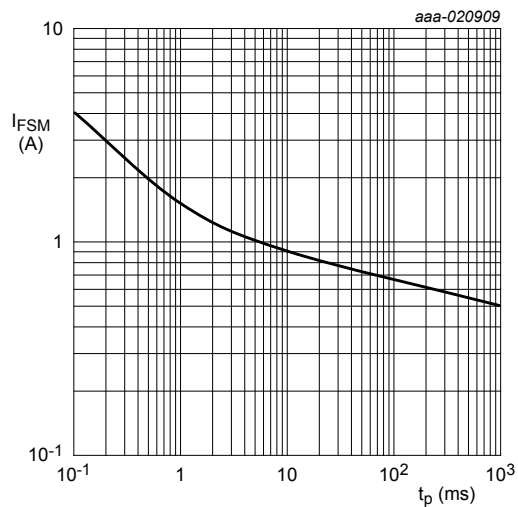


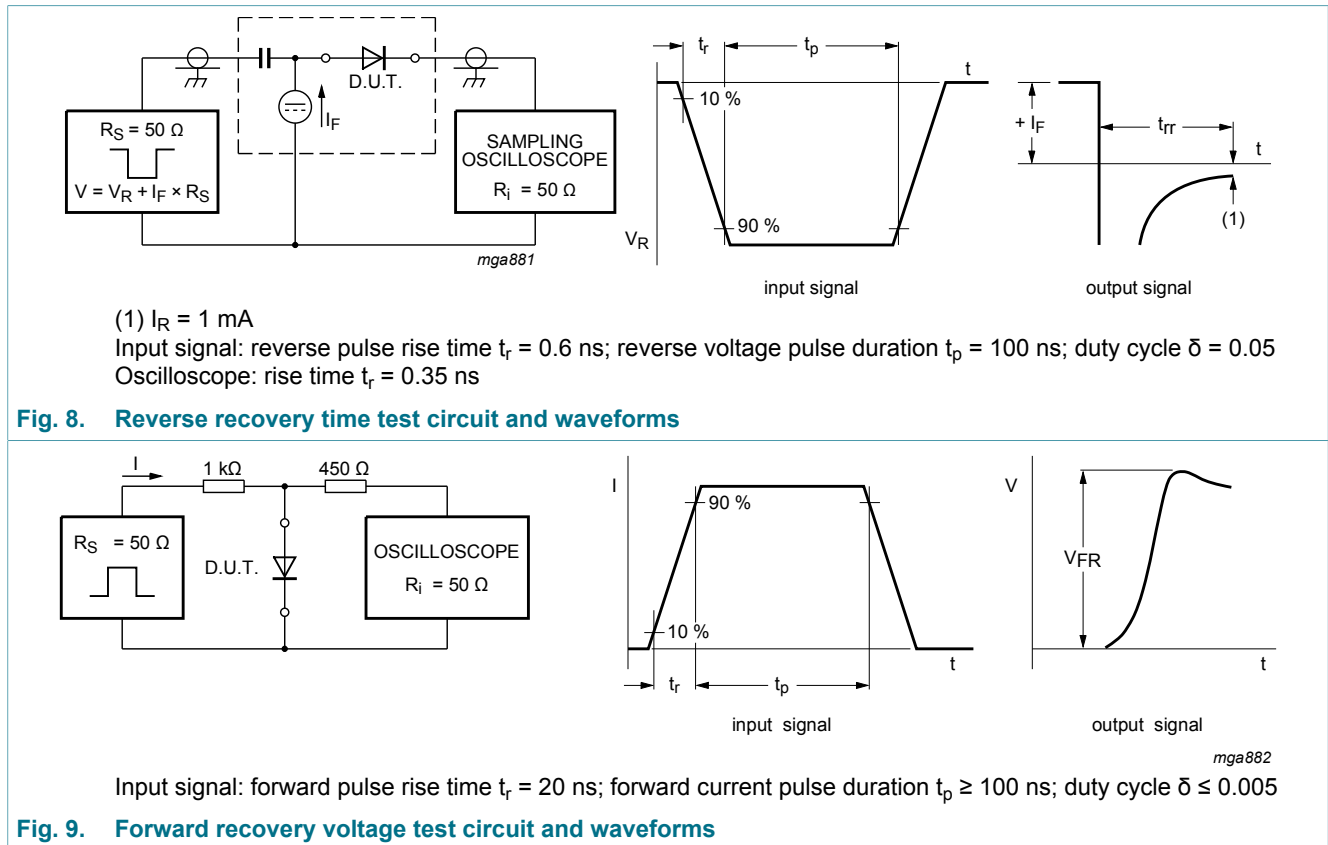
Fig. 6. Diode capacitance as a function of reverse voltage; typical values



Based on square wave currents.
 $T_{\text{amb}} = 25\text{ }^{\circ}\text{C}$

Fig. 7. Non-repetitive forward current as a function of pulse duration; maximum values

11. Test information



Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

12. Package outline

DFN1412-6: plastic thermal enhanced ultra thin small outline package; no leads;
6 terminals; body: 1.4 x 1.2 x 0.47 mm

SOT1268

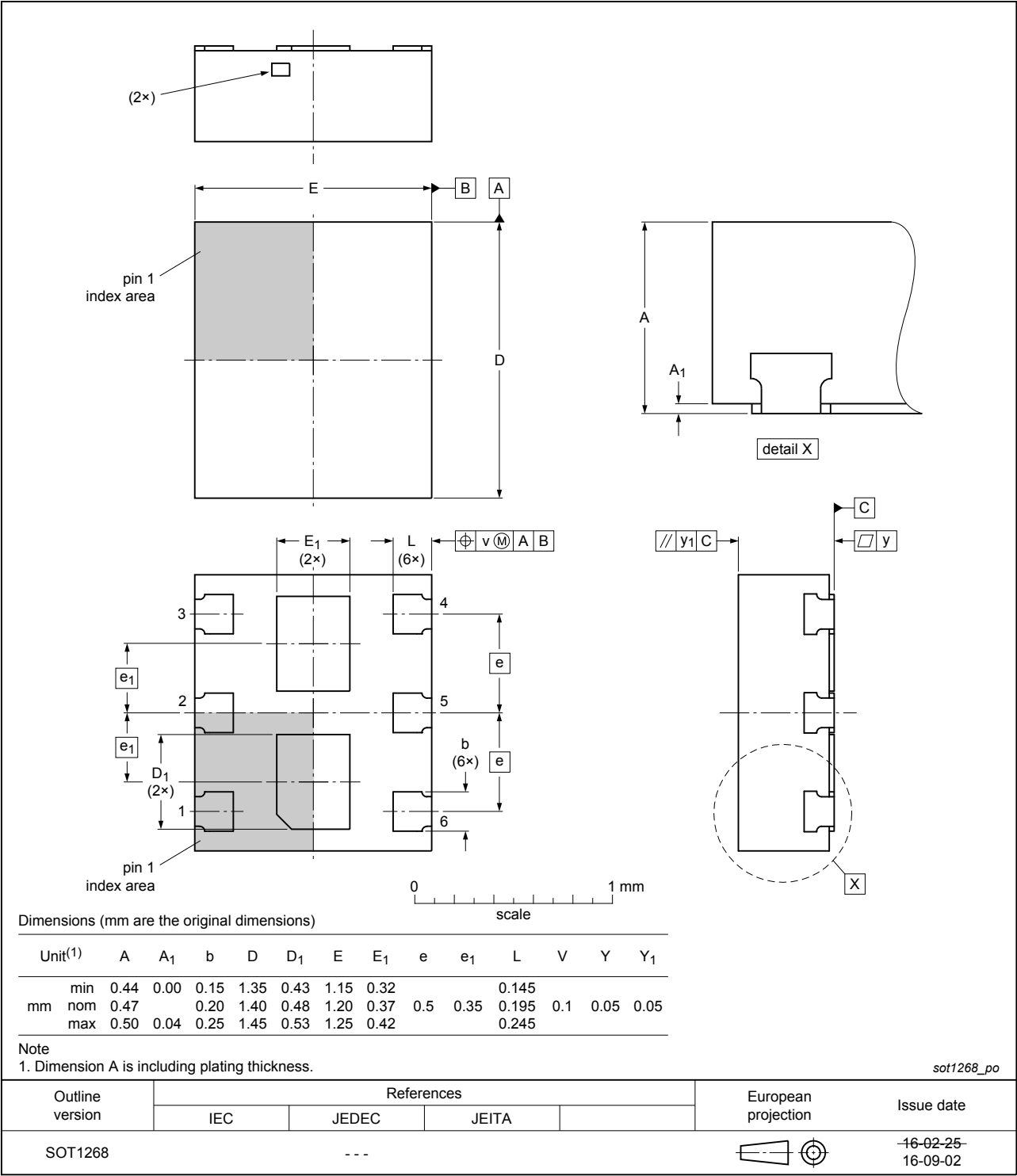


Fig. 10. Package outline DFN1412-6 (SOT1268)

13. Soldering

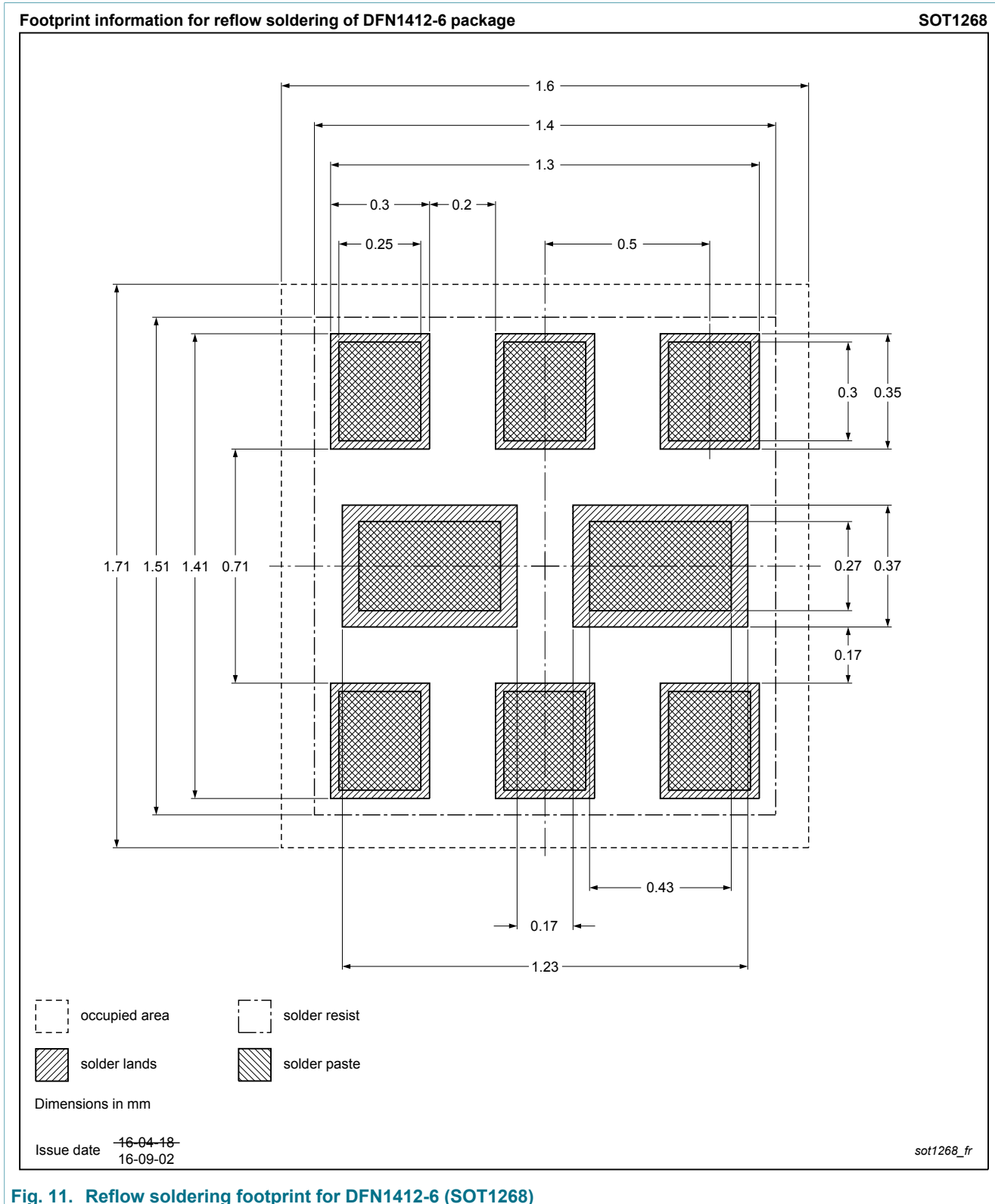


Fig. 11. Reflow soldering footprint for DFN1412-6 (SOT1268)

14. Revision history

Table 8. Revision history

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
BAV70SRA v.1	20170626	Product data sheet	-	-

15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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- [2] The term 'short data sheet' is explained in section "Definitions".
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For sales office addresses, please send an email to: salesaddresses@nexperia.com

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